091-893316

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Attention: Certificate of Correction Branch, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: **61/9/2007** Signature:

Melody Hem

CofC

Docket No.: 291958161US1 Client Ref No. 01-0046US2

(PATENT)



#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Letters Patent of:

Reardon et al.

Patent No.: 7,094,291

Issued: August 22, 2006

For: SEMICONDUCTOR PROCESSING SPRAY

**COATING APPARATUS** 

Certificate

JAN 2 4 2007

of Correction

# REQUEST FOR CERTIFICATE OF CORRECTION PURSUANT TO 37 CFR 1.322

Attention: Certificate of Correction Branch

**Commissioner for Patents** 

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Upon reviewing the above-identified patent, Patentee noted a typographical error which should be corrected.

In the Specification:

Front page, cited references: Please include the cited references from the resubmission of an Information Disclosure Statement filed June 17, 2005. The original Information Disclosure Statement was filed December 31, 2001 but did not include copies of references.

The error was not in the application as filed by applicant; accordingly no fee is required.

Patent No.: 7,094,291 Docket No.: 291958161US1

Transmitted herewith is a proposed Certificate of Correction effecting such amendment. Patentee respectfully solicits the granting of the requested Certificate of Correction.

Applicant believes no fee is due with this request. However, if a fee is due, please charge our Deposit Account No. 50-0665, under Order No. 291958161US1 from which the undersigned is authorized to draw.

Dated: <u>January</u> 19, 2006

Respectfully submitted,

Paul T. Parker

Registration No.: 38,264

PERKINS COIE LLP

P.O. Box 1247

Seattle, Washington 98111-1247

(206) 359-8000

(206) 359-7198 (Fax)

Attorney for Applicant

### UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

Page \_1\_ of \_3\_

PATENT NO.

7,094,291

APPLICATION NO. :

09/893,316

ISSUE DATE

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INVENTOR(S)

Reardon et al.

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US-4,895,099	01-23-1990	D'Amato	US-4,900,395	02-13-1990	Syverson et al.
US-4,923,054	05-08-1990	Ohtani et al.	US-4,924,800	05-15-1990	Tanaka
US-4,932,353	06-12-1990	Kawata et al.	US-4,936,940	06-26-1990	Kawasumi et al.
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US-5,358,740	10-25-1994	Bornside et al.	US-5,378,511	01-03-1995	Cardinali et al.
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## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

Page \_2\_ of \_3\_

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US-4,378,511	03-29-1983	Simovits, Jr.	US-4,403,617	09-13-1983	Tretinyak
US-4,416,213	11-22-1983	Sakiya	US-4,429,912	02-07-1984	Smith, Jr.
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JP-54-71991	06-08-1979	Matsushita Electronics Corp.			
JP-3010-974	08-15-1979	Matsushita Elec Ind. Co. Ltd.			

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APPLICATION NO.

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۱	JP-3010-974	08-15-1979	Matsushita Elec Ind. Co. Ltd.				

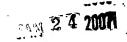
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